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NC7WZ07 TinyLogic[®] UHS Dual Buffer (Open-Drain Outputs)

Features

- Ultra-High Speed: t_{PZL} 2.3 ns (Typical)
- High I_{OL} Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.50 V
- Power Down High Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak[™] Packages

Description

The NC7WZ07 is a dual buffer with open-drain outputs from Fairchild's Ultra-High Speed (UHS) series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive, while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over a very broad V_{CC} operating range. The device is specified to operate over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} range. The inputs and outputs are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 7 V independent of V_{CC} operating voltage.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7WZ07P6X	Z07	6-Lead SC70, EIAJ SC88 1.25 mm Wide	3000 Units on Tape & Reel
NC7WZ07L6X	D3	6-Lead MicroPak™, 1.00 mm Wide	5000 Units on Tape & Reel
NC7WZ07FHX	D3	6-Lead, MicroPak2™, 1x1 mm Body, .35 mm Pitch	5000 Units on Tape & Reel

Connection Diagrams

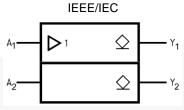
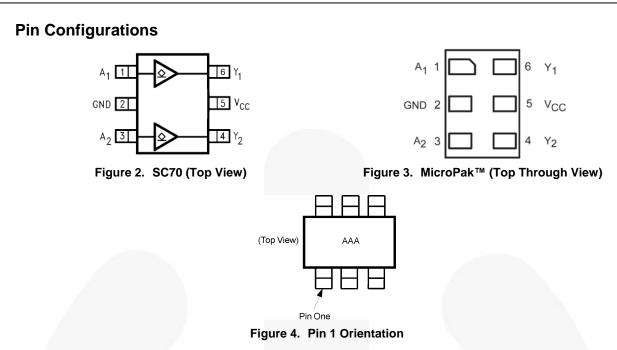


Figure 1. Logic Symbol



Notes:

- AAA represents product code top mark (see Ordering Information). Orientation of top mark determines pin one location. 1.
- 2.
- Reading the top mark left to right, pin one is the lower left pin. 3.

Pin Definitions

Pin # SC70	Pin # MicroPak™ Name		Description
1	1	A ₁	Input
2	2	GND	Ground
3	3	A ₂	Input
4	4	Y ₂	Output
5	5	V _{cc}	Supply Voltage
6	6	Y ₁	Output

Function Table

Y= A

Inputs	Output
Α	Y
LOW Logic Level	LOW Logic Level
HIGH Logic Level	High Impedance Output State, Open Drain

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	ameter	Min.	Max.	Unit
V _{CC}	Supply Voltage		-0.5	7.0	V
V _{IN}	DC Input Voltage		-0.5	7.0	V
V _{OUT}	DC Output Voltage		-0.5	7.0	V
I _{IK}	DC Input Diode Current	V _{IN} < -0.5 V		-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < -0.5 V		-50	mA
I _{OUT}	DC Output Current		±50	mA	
I _{CC} or I _{GND}	DC V _{CC} or Ground Current			±100	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under B	ias		+150	°C
TL	Junction Lead Temperature (Se	oldering, 10 Seconds)		+260	°C
		SC70-6		150	
PD	Power Dissipation at +85°C	MicroPak™-6		130	mW
	MicroPak2™-6			120	
ESD	Human Body Model, JEDEC:JE		4000	v	
ESD	Charge Device Model, JEDEC:	JESD22-C101		2000	V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
M	Supply Voltage Operating		1.65	5.50	V
V _{cc}	Supply Voltage Data Retention		1.5	5.5	v
V _{IN}	Input Voltage		0	5.5	V
V _{OUT}	Output Voltage		0	5.5	V
		V _{CC} at 1.8 V, ±0.15 V, 2.5 V ± 0.2 V	0	20	
t _r , t _f	Input Rise and Fall Times	V _{CC} at 3.3 V ±0.3 V	0	10	ns/V
		V _{CC} at 5.0 V ±0.5 V	0	5	<)
T _A	Operating Temperature		-40	+85	°C
		SC70-6		425	
θ_{JA}	Thermal Resistance	MicroPak™-6		500	°C/W
		MicroPak2™-6		560	

Note:

4. Unused inputs must be held HIGH or LOW. They may not float.

•		N/		T _A =+25°C		С	T _A =-40 to +85°C		
Symbol	Parameter	V _{cc}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
N/	HIGH Level Input	1.65 to 1.95		$0.75V_{CC}$			$0.75V_{CC}$		V
V _{IH}	Voltage	2.30 to 5.50		0.70V _{CC}			$0.70V_{CC}$		v
M	LOW Level Input	1.65 to 1.95				$0.25V_{CC}$		$0.25V_{CC}$	V
V _{IL}	Voltage	2.30 to 5.50				$0.30V_{CC}$		$0.30V_{CC}$	v
I _{LKG}	HIGH Level Output Leakage Current	1.65 to 5.50	$V_{IN}=V_{IH},$ $V_{OUT}=V_{CC}$ or GND			±5		±10	μA
		1.65			0.00	0.10		0.00	
		1.80			0.00	0.10		0.10	
	2.30	$V_{IN}=V_{IL}$, $I_{OL}=100 \ \mu A$		0.00	0.10		0.10	l	
		3.00			0.00	0.10		0.10	
V _{OL}	LOW Level Output	4.50			0.00	0.10		0.10	V
VOL	Voltage	1.65	I _{OL} =4 mA		0.80	0.24		0.24	
		2.30	I _{OL} =8 mA		0.10	0.30		0.30	
		3.00	I _{OL} =16 mA		0.16	0.40		0.40	
		3.00	I _{OL} =24 mA		0.24	0.55		0.55	
		4.50	I _{OL} =32 mA		0.25	0.55		0.55	
I _{IN}	Input Leakage Current	0 to 5.5	$0 \leq V_{\text{IN}} \leq 5.5 \text{ V}$			±0.1		±1.0	μA
I _{OFF}	Power Off Leakage Current	0	V _{IN} or V _{OUT} =5.5 V			1		10	μA
I _{cc}	Quiescent Supply Current	1.65 to 5.50	V _{IN} =5.5 V, GND			1		10	μA

		-40 to 5°C	Units	Figure
Max.	Min.	Max.		
11.5	1.8	12.6		
9.5	1.8	10.5		
5.8	1.2	6.4		
4.4	0.8	4.8	ns	
3.5	0.5	3.9		Figure 5
11.5	1.8	12.6		Figure 6
9.5	1.8	10.5		
5.8	1.2	6.4		
4.4	0.8	4.8		
3.5	0.5	3.9		
			pF	
			pF	Figure 7
			•	•

 t_{PZL}, t_{PLZ}

 C_{IN}

COUT

 C_{PD}

Symbol

AC Electrical Characteristics

Parameter

Propagation Delay

Input Capacitance

Output Capacitance

Power Dissipation

Capacitance⁽⁵

 V_{cc}

1.65

1.80

 2.50 ± 0.20

 3.30 ± 0.30

 5.00 ± 0.50

1.65

1.80

 2.50 ± 0.20

 3.30 ± 0.30

 5.00 ± 0.50

0

0

3.30

5.00

Conditions

C_L=50 pF,

RU=500 Ω,

RD=500 Ω,

 $V_{I}=2 \times V_{CC}$

 $C_{L}=50 \text{ pF},$

RU=500 Ω,

RD=500 Ω,

 $V_I=2 \times V_{CC}$

Note:

C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}static).

T₄=+25°C

Тур.

6.6

5.5

3.7

2.9

2.3

5.5

4.3

2.8

2.1

1.4

2.5

4.0

3

4

Min.

1.8

1.8

1.2

0.8

0.5

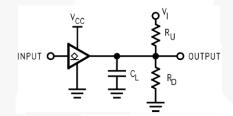
1.8

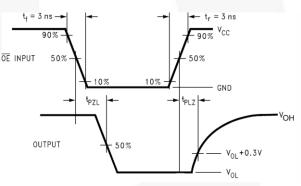
1.8

1.2

0.8

0.5





Notes:

6. C_L includes load and stray capacitance.

7. Input PRR = 1.0MHz, $t_W = 500$ ns.

Figure 5. AC Test Circuit



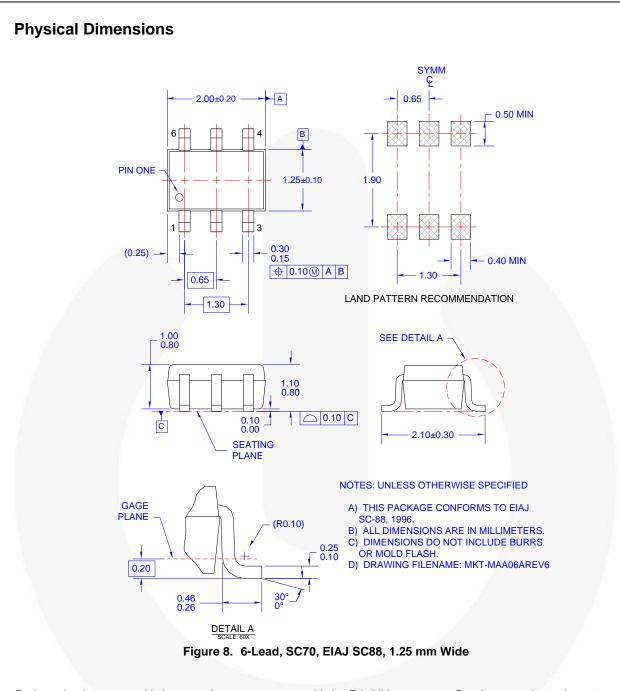


- 8. Input=AC Waveform; $t_r=t_f=1.8$ ns.
- 9. PRR=Variable; Duty Cycle=50%.



INPUT C

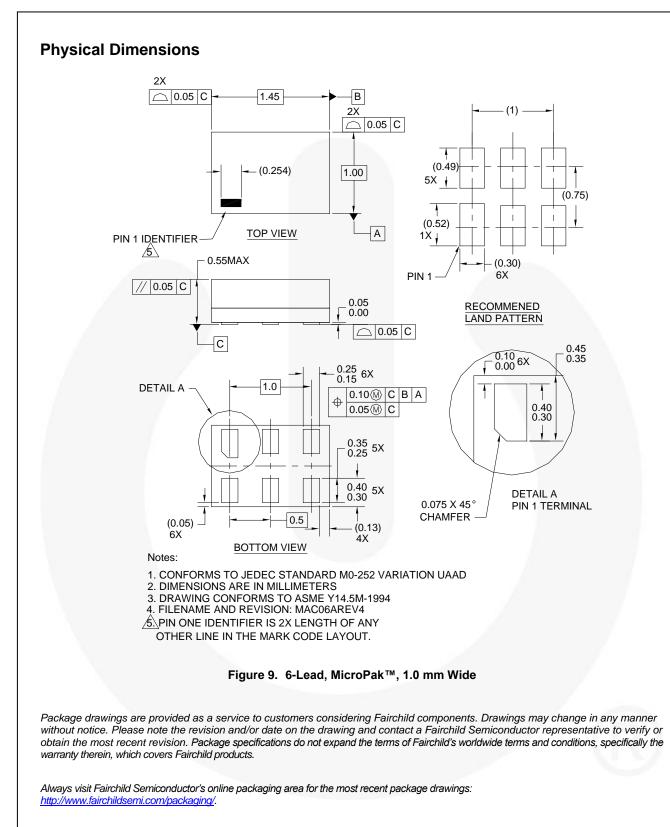
V_{CC}



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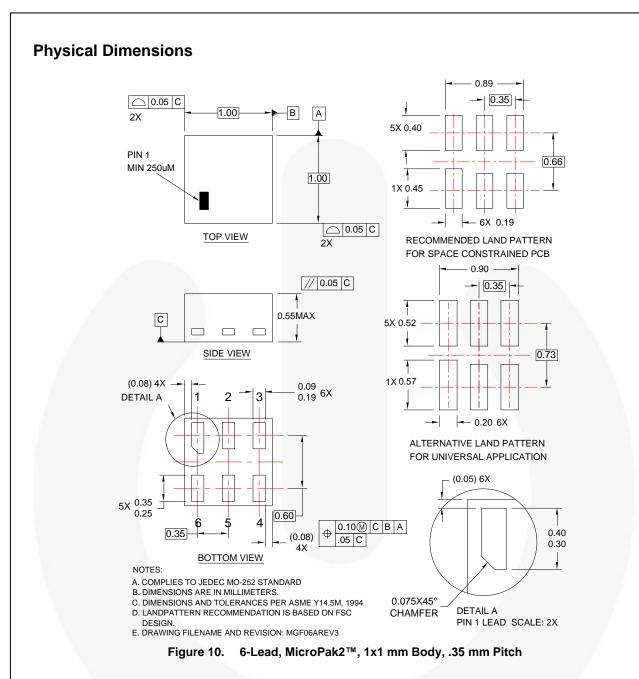
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P6X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Rev. 164

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